Vertical-Chips・Glass Package 垂直芯片・玻璃封装 Single Color LEDs **单色光**源

Main Applications: 主要应用领域:

- ✓ directional projection and beam lighting with small angle for projection, light beam, dyeing, pattern, audience, business, hotel, museum, etc.
 小角度方向性投射类照明,适用于投射,光束,染色,图案,观众,商 业,酒店,博物馆等
- ✓ medical and micro-instrument lighting
 医疗与显微器械照明

<u>S1173b</u>

Chip with circular light emitting surface	

Main Parameters	Typical Values
Voltage (V)	3
Current (mA)	5225
Max. Power(W) ^{Note}	20
LES (mm)	1.8
CCT (K) / Ra	8350-9000
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	H003-2020 H013-1818 H041-1818 H063-3333

Note: The maximum power only for reference and related to the heat dissipation power of the radiator, the thermal resistance between the radiator and the light source and the ambient temperature.

Main	Low Power Single Color Integrated Lighting Source;
Features	Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;
	Vertical Chips Capable of Super-Driving Current for Highly Intensive Lighting;
	Customizing Other Power, LES, Color Combination, CCT and Ra;

Applicable to Directional Projection Lighting with High Brightness.



<u>S1146</u>

Special Stage and Landscape Lighting 特种舞台景观照明



Main Parameters	Typical Values
Voltage (V)	12
Current (mA)	3950
Max. Power(W) ^{Note}	55
LES (mm)	3.3x2.6
CCT (K) / Ra	8350-9000
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	H004/H010-2020 H015/H030-1818 H018-2728

Note: The maximum power only for reference and related to the heat dissipation power of the radiator, the thermal resistance between the radiator and the light source and the ambient temperature.

Main Features	Middle Power Single Color Integrated Lighting Source;
	Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;
	Vertical Chips Capable of Super-Driving Current for Highly Intensive Lighting;
	Customizing Other Power, LES, Color Combination, CCT and Ra;

Applicable to Directional Projection Lighting with High Brightness.



<u>S1392</u>

Special Stage and Landscape Lighting 特种舞台景观照明



Main Parameters	Typical Values
Voltage (V)	12
Current (mA)	7540
Max. Power(W) ^{Note}	117
LES (mm)	4.2x4.2
CCT (K) / Ra	12500-14500
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	H004/H010-2020 H015/H030-1818 H018-2728

Note: The maximum power only for reference and related to the heat dissipation power of the radiator, the thermal resistance between the radiator and the light source and the ambient temperature.

Main Features	Middle Power Single Color Integrated Lighting Source;
	Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;
	Vertical Chips Capable of Super-Driving Current for Highly Intensive Lighting;

Customizing Other Power, LES, Color Combination, CCT and Ra;

Applicable to Directional Projection Lighting with High Brightness $_{\circ}$





Main Parameters	Typical Values
Voltage (V)	21
Current (mA)	3950
Max. Power(W) ^{Note}	97
LES (mm)	5.2x4.7
CCT (K) / Ra	8350-9000
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	H053-3636 H057-2728

Note: The maximum power only for reference and related to the heat dissipation power of the radiator, the thermal resistance between the radiator and the light source and the ambient temperature.

Main	Middle Power Single Color Integrated Lighting Source;
Features	Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;
	Vertical Chips Capable of Super-Driving Current for Highly Intensive Lighting;

Customizing Other Power, LES, Color Combination, CCT and $\mbox{Ra}\,;$

Applicable to Directional Projection Lighting with High Brightness $_{\circ}$





Main Parameters	Typical Values
Voltage (V)	27
Current (mA)	3950
Max. Power(W) ^{Note}	125
LES (mm)	5x5.25
CCT (K) / Ra	8350-9000
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	H053-3636 H057-2728

Note: The maximum power only for reference and related to the heat dissipation power of the radiator, the thermal resistance between the radiator and the light source and the ambient temperature.

Main Features	Middle Power Single Color Integrated Lighting Source;
	Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;
	Vertical Chips Capable of Super-Driving Current for Highly Intensive Lighting;

Customizing Other Power, LES, Color Combination, CCT and Ra;

Applicable to Directional Projection Lighting with High Brightness.

